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Pr Ca Multilayer Ceramic Chip Capacitors Detailed Information Multilayer Ceramic Chip Capacitors Product Top Page Search by Part No. Search by Characteristics Technical Support Tool Cross Reference Catalog Tech Notes C1608C0G2A103J080AC TDK item description ? C1608C0G2A103JT**** PDF file of this page Commercial Grade **Applications Buy Now** Please refer to Part No. CGA3E1C0G2A103J080AC for Automotive use Mid Voltage (100 to 630V) **Feature** Contact Series C1608 [EIA 0603] **Documents** Production **Status** Catalog Specification RoHS Certificate 0000 SVHC/REACH Certificate Images are for reference only and show exemplary products. Characterization Sheet Promotion Video Size Sample Kits Length(L) 1.60mm ±0.10mm Width(W) 0.80mm ±0.10mm 0.80mm ±0.10mm Thickness(T) Terminal Width(B) 0.20mm Min. Terminal Spacing(G) 0.30mm Min. 0.70mm to 1.00mm(Flow Soldering) Recommended Land Pattern (PA) 0.60mm to 0.80mm(Reflow Soldering) 0.80mm to 1.00mm(Flow Soldering) Recommended Land Pattern (PB) 0.60mm to 0.80mm(Reflow Soldering) 0.60mm to 0.80mm(Flow Soldering) Recommended Land Pattern (PC) 0.60mm to 0.80mm(Reflow Soldering) **Electrical Characteristics** 10nF ±5% Capacitance Rated Voltage 100VDC Temperature Characteristic ? C0G(0±30ppm/°C) Q (Min.) 1000 Insulation Resistance (Min.) $10000M\Omega$ Other

Application Guides | Technical Support

Characteristic Graph (This is reference data, and does not guarantee the products characteristics.)

Punched (Paper)Taping [180mm Reel]

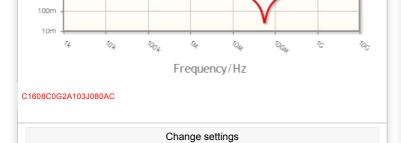
Wave (Flow)

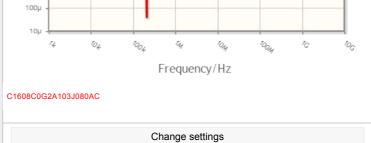
Reflow

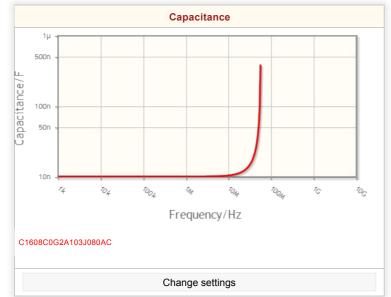
4000pcs

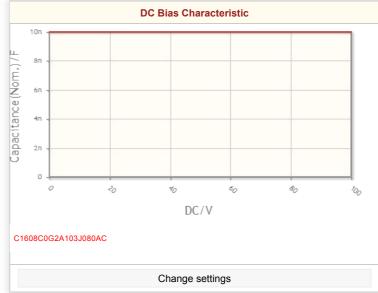


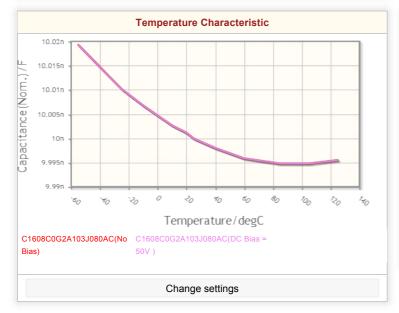














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